# onsemi

# IGBT - Ultra Field Stop NGTB40N120FL3WG

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Ultra Field Stop Trench construction, and provides superior performance in demanding switching applications, offering both low on–state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

#### Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- These are Pb-Free Devices

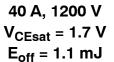
#### **Typical Applications**

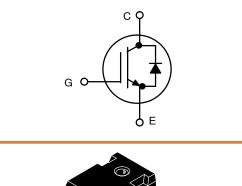
- Solar Inverter
- Uninterruptible Power Inverter Supplies (UPS)
- Welding

#### **ABSOLUTE MAXIMUM RATINGS**

Value           1200           80 40           160	Unit V A A
80 40	A
40	A
160	
80 40	A
160	A
±20 ±30	V
454 227	W
–55 to +175	°C
-55 to +175	°C
000	°C
	227 -55 to +175

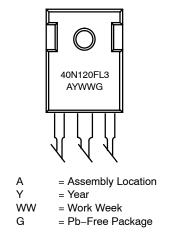
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.







MARKING DIAGRAM



#### ORDERING INFORMATION

Device	Package	Shipping
NGTB40N120FL3WG	TO–247 (Pb–Free)	30 Units / Rail

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{\theta JC}$	0.33	°C/W
Thermal resistance junction-to-case, for Diode	$R_{\theta JC}$	0.61	°C/W
Thermal resistance junction-to-ambient	$R_{\theta JA}$	40	°C/W

#### **ELECTRICAL CHARACTERISTICS** ( $T_J = 25^{\circ}C$ unless otherwise specified)

Parameter	Test Conditions		Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE}$ = 0 V, I <sub>C</sub> = 500 $\mu$ A	V <sub>(BR)CES</sub>	1200	-	-	V
Collector-emitter saturation voltage	$V_{GE}$ = 15 V, I <sub>C</sub> = 40 A V <sub>GE</sub> = 15 V, I <sub>C</sub> = 40 A, T <sub>J</sub> = 175°C	V <sub>CEsat</sub>	- -	1.7 2.3	1.95 -	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}$ , $I_C = 400 \ \mu A$	V <sub>GE(th)</sub>	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate-emitter short-circuited	$V_{GE} = 0 V$ , $V_{CE} = 1200 V$ $V_{GE} = 0 V$ , $V_{CE} = 1200 V$ , $T_{J} = 175^{\circ}C$	ICES		_ 0.5	0.4 _	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE}$ = 20 V , $V_{CE}$ = 0 V	I <sub>GES</sub>	-	-	200	nA

Input capacitance		Cies	-	4912	-	pF
Output capacitance	V <sub>CE</sub> = 20 V, V <sub>GE</sub> = 0 V, f = 1 MHz	C <sub>oes</sub>	-	140	-	
Reverse transfer capacitance		C <sub>res</sub>	-	80	-	
Gate charge total		Qg	-	212	-	nC
Gate to emitter charge	$V_{CE}$ = 600 V, $I_{C}$ = 40 A, $V_{GE}$ = 15 V	Q <sub>ge</sub>	-	43	-	
Gate to collector charge		Q <sub>qc</sub>	-	102	-	1

#### SWITCHING CHARACTERISTIC, INDUCTIVE LOAD

Turn-on delay time		t <sub>d(on)</sub>	-	18	-	ns
Rise time		t <sub>r</sub>	-	31	-	1
Turn-off delay time	$T_{J} = 25^{\circ}C$ $V_{CC} = 600 \text{ V, } I_{C} = 40 \text{ A}$	t <sub>d(off)</sub>	-	145	-	1
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 40 \text{ A}$ $B_{c} = 10 \Omega$	t <sub>f</sub>	-	107	-	1
Turn-on switching loss	$R_g = 10 \Omega$ V <sub>GE</sub> = 15V	E <sub>on</sub>	-	1.6	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	1.1	-	1
Total switching loss		E <sub>ts</sub>	-	2.7	-	1
Turn-on delay time		t <sub>d(on)</sub>	-	20	-	ns
Rise time		t <sub>r</sub>	-	31	-	1
Turn-off delay time	T <sub>J</sub> = 175°C	t <sub>d(off)</sub>	-	153	-	1
Fall time	$T_{J} = 175^{\circ}C$ $V_{CC} = 600 \text{ V, }I_{C} = 40 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 15 \text{ V}$	t <sub>f</sub>	-	173	-	1
Turn-on switching loss	V <sub>GE</sub> = 15 V	Eon	-	2.2	-	mJ
Turn-off switching loss		E <sub>off</sub>	-	1.7	-	1
Total switching loss		E <sub>ts</sub>	-	3.9	-	1

#### **DIODE CHARACTERISTIC**

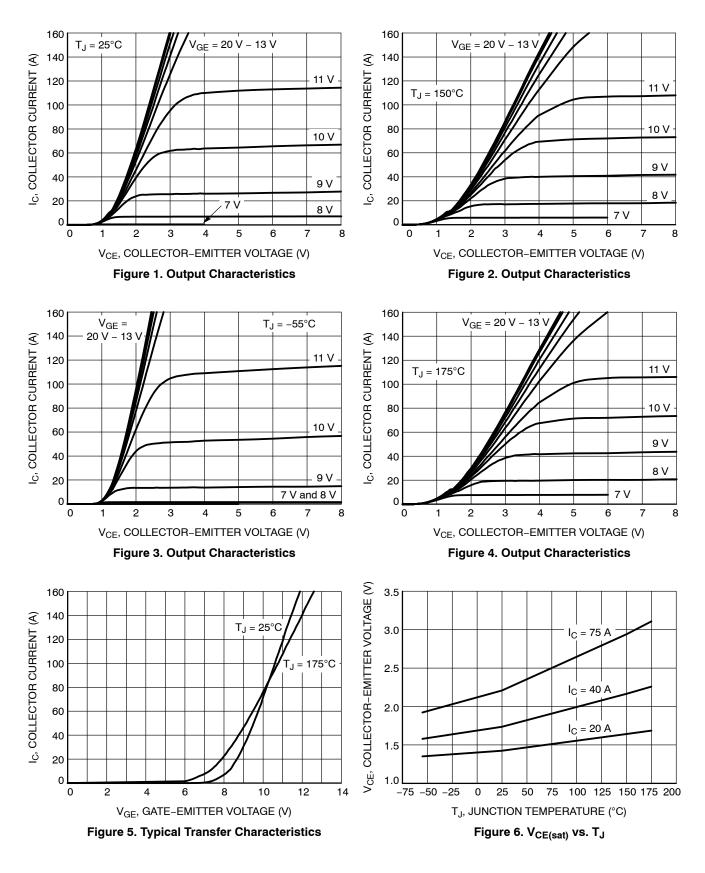
Forward voltage	$V_{GE}$ = 0 V, I <sub>F</sub> = 40 A $V_{GE}$ = 0 V, I <sub>F</sub> = 40 A, T <sub>J</sub> = 175°C	V <sub>F</sub>		3.0 2.8	3.4	V
Reverse recovery time		t <sub>rr</sub>	-	86	-	ns
Reverse recovery charge	T.I = 25°C	Q <sub>rr</sub>	-	0.56	-	μc
Reverse recovery current	$I_{\rm F} = 40$ Å, $V_{\rm R} = 600$ V	I <sub>rrm</sub>	-	12	-	A
Diode peak rate of fall of reverse recovery current during tb	di <sub>F</sub> /dt = 500 A/µs	dl <sub>rrm</sub> /dt	-	-210	-	A/μs

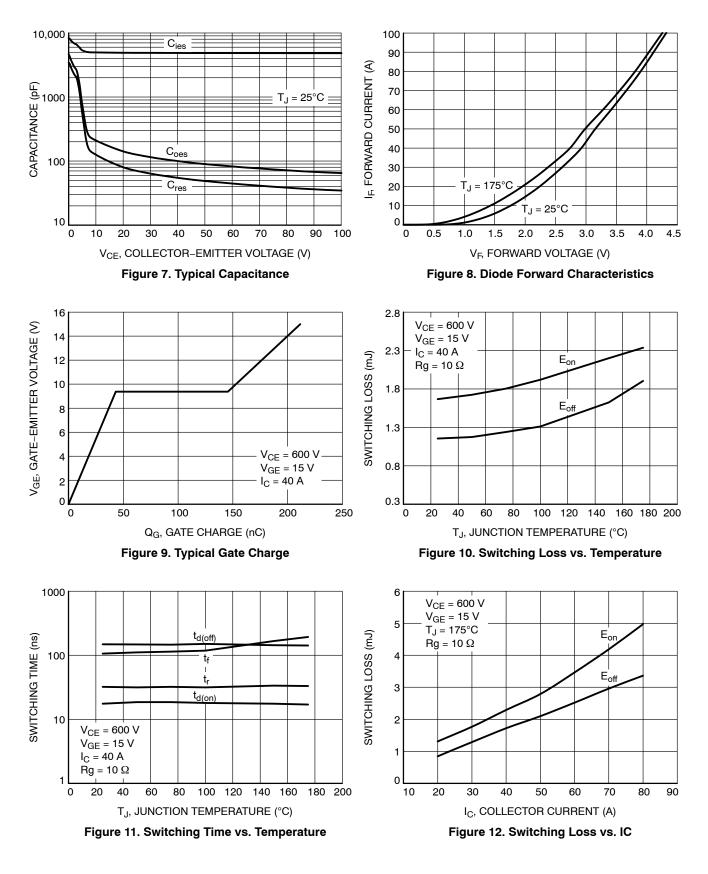
# **ELECTRICAL CHARACTERISTICS** ( $T_J$ = 25°C unless otherwise specified) (continued)

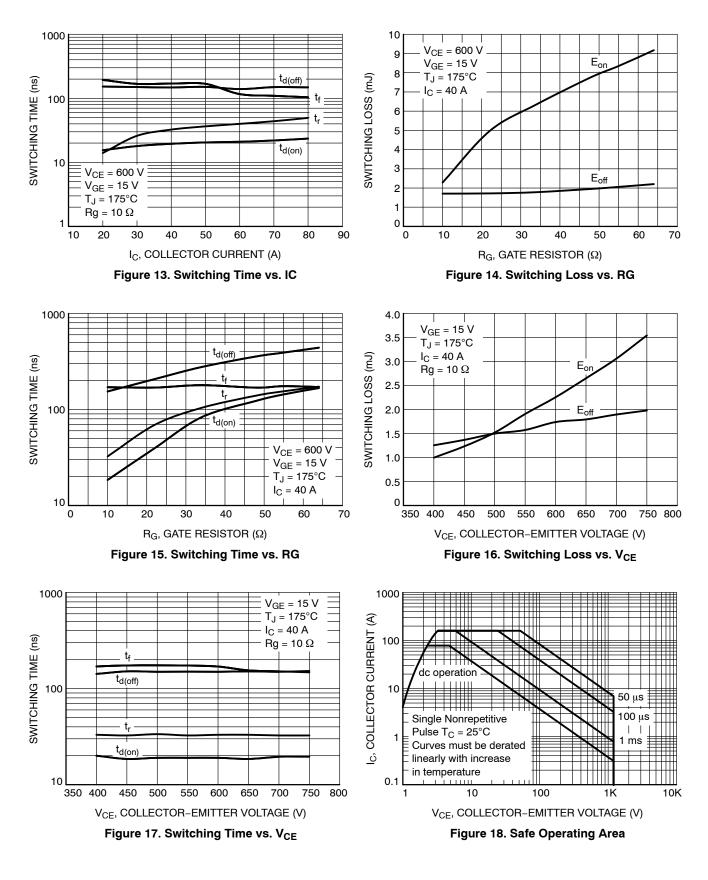
Parameter	Parameter Test Conditions		Min	Тур	Max	Unit
DIODE CHARACTERISTIC					-	-
Reverse recovery time		t <sub>rr</sub>	-	136	-	ns
Reverse recovery charge	T₁ = 125°C	Q <sub>rr</sub>	-	1.47	-	μο
Reverse recovery current	$T_J = 125^{\circ}C$ $I_F = 40 \text{ A}, V_R = 600 \text{ V}$	I <sub>rrm</sub>	-	20	-	А
Diode peak rate of fall of reverse recovery current during tb	di <sub>F</sub> /dt = 500 A/µs	dl <sub>rrm</sub> /dt	_	-212	_	A/μs

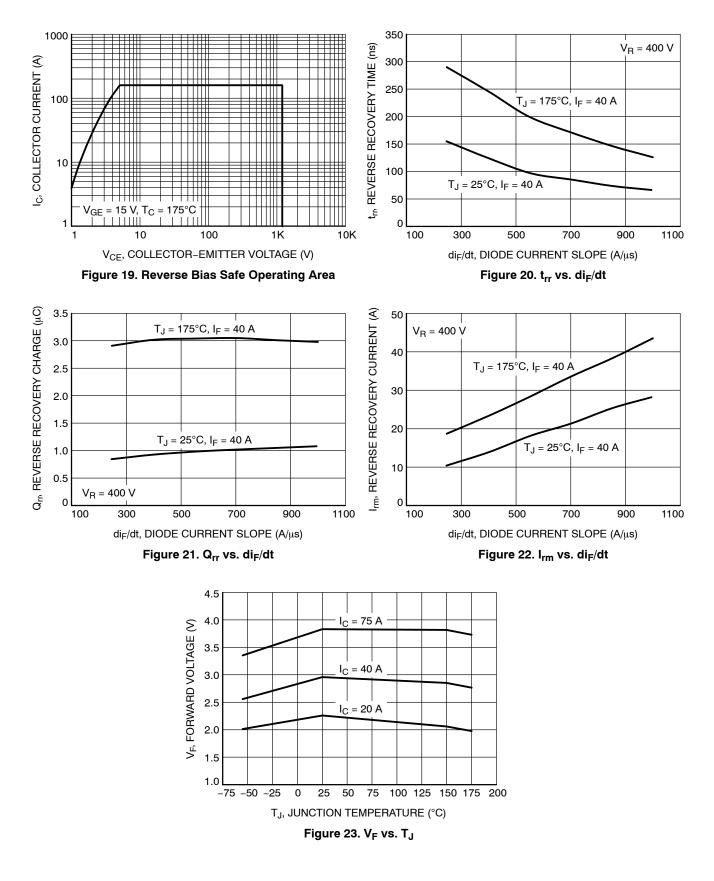
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

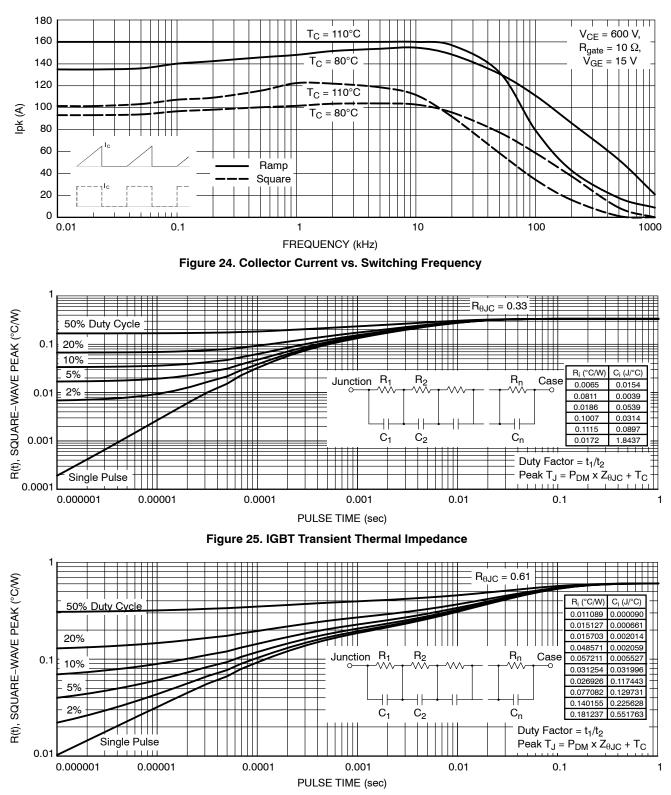
#### **TYPICAL CHARACTERISTICS**













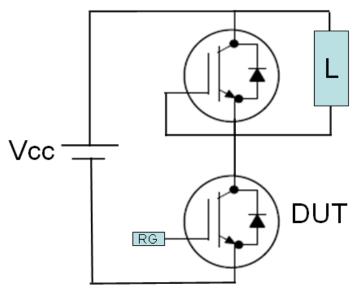


Figure 27. Test Circuit for Switching Characteristics

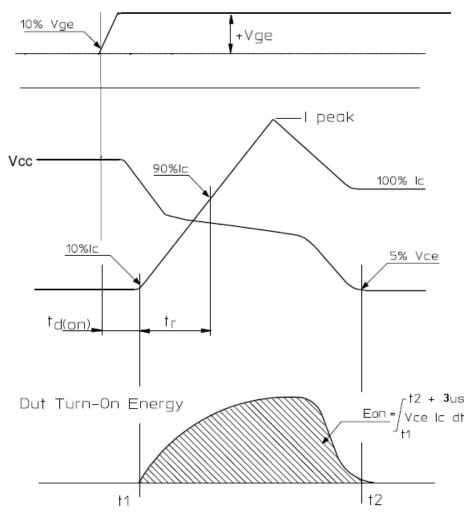
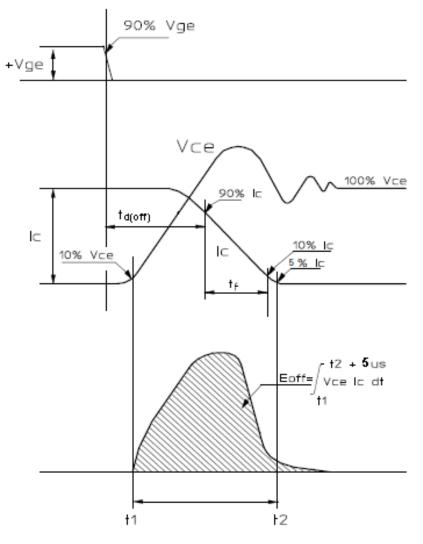
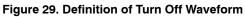
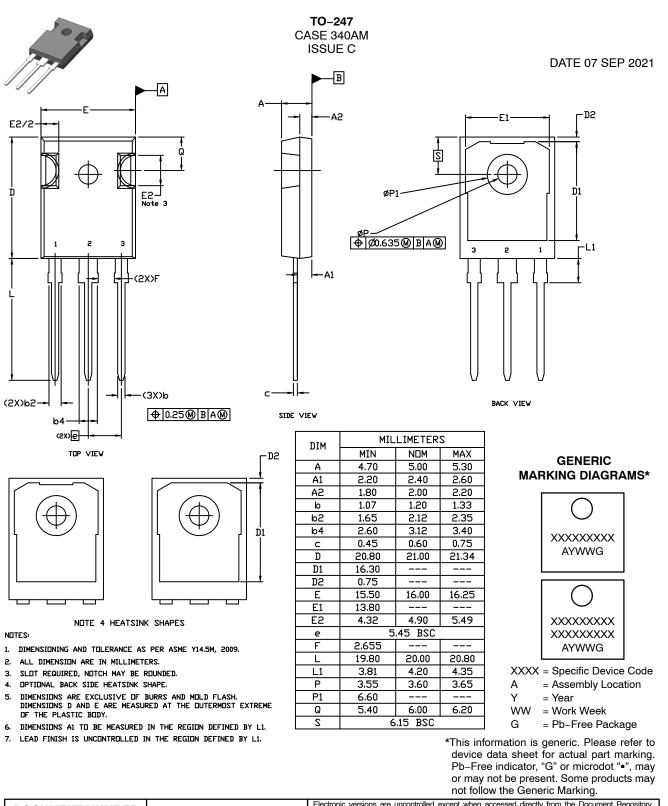


Figure 28. Definition of Turn On Waveform









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